

Call for Papers

# 52<sup>nd</sup> IEEE International Symposium on Multiple-Valued Logic

## ISMVL 2022



The Multiple-Valued Logic Technical Committee of the IEEE Computer Society will hold its 52<sup>nd</sup> annual symposium in **Virtual mode** on May 18-20, 2022. You are invited to submit original papers, surveys, or tutorial papers on any subject in the area of multiple-valued logic, including but not limited to:

**Algebra and Formal Aspects**  
**Automatic Reasoning**  
**Logic Programming**  
**Philosophical Aspects of MVL**  
**Fuzzy Logic and Soft Computing**  
**Data Mining**  
**Machine Learning**  
**Quantum Informatics**  
**Reversible Computing**  
**MVL aspects of Autonomous Systems**

**Logic Design and Switching Theory**  
**Test and Verification**  
**Spectral Techniques**  
**Circuit/Device Implementation**  
**VLSI Architecture and Computing**  
**System-on-Chip Technology**  
**MVL in Nanotechnology**  
**MVL in Medical Technologies**  
**MVL in Data Science and Analytics**  
**MVL in Computer Security**

Authors should submit papers through the [EasyChair website](#) as PDF files following the IEEE style guidelines for conference proceedings. Each manuscript should include a 50-100 word abstract and be 6 pages in length. Up to 2 additional pages may be included with extra page charges of \$100 per page. All accepted papers will be published by IEEE and appear in IEEEExplore. More information can be found at [ISMVL 2022 website](#).

In conjunction with the conference, the international Workshop on Post-Binary ULSI Systems (ULSIWS) will be held on May 18, 2022. A separate call for papers for ULSIWS is available at the [ULSIWS website](#).

**Paper Submission :**

November 1, 2021

December 1, 2021

December 17, 2021

**Author Notification:**

January 28, 2022

**Camera-Ready Version:**

February 25, 2022

**ISMVL Symposium:**

May 18-20, 2022

**ULSI Workshop:**

May 18, 2022 (morning)

**For questions, please contact:**

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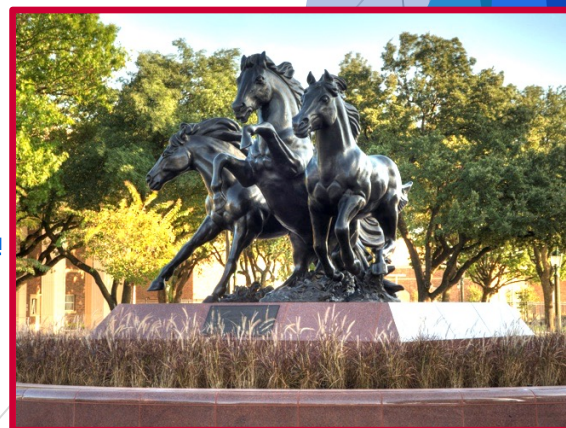
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